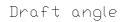
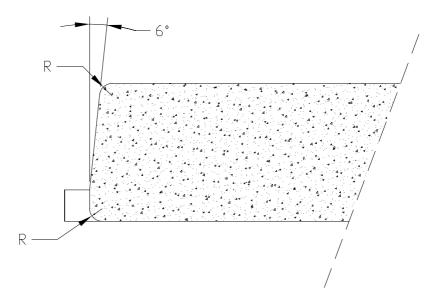


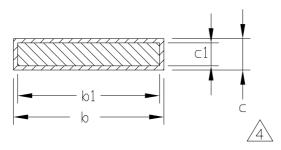
JEDEC SOLID STATE PRODUCT OUTLINES THIS **REGISTERED OUTLINE** Has been prepared by the JEDEC JC-11 Committee and reflects a product with anticipated usage in the Electronics industry, Changes are likely to occur.

TITLE	PACKAGE DESIGNATOR	ISSUE	DATE	ITEM #	SHEET 1
SMALL DUTLINES PLASTIC Surface mount package	T-PSON-3	A	Jan. 2006	TD-277	ог 3

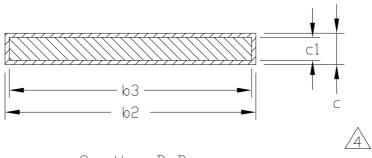




Detail A



Section A-A (terminal cross-section)



Section B-B (terminal cross-section)

JEDEC	TITLE:	ISSUE	DATE	ITEM #	SHEET
	SMALL DUTLINES PLASTIC SURFACE MOUNT PACKAGE		Jan. 2006	TD-277	0F 3

Symbol				
	Min	Nom	Max	
А	1.00	1.10	1.20	
b b1 b2 b3 b4 ⊂	1.00 1.00 1.85 1.80 0.25 0.15	1.20 1.20 2.05 2.00 0.65 0.25 0.25	1.40 1.35 2.25 2.15 1.00 0.40 0.35	
D D1 D2 E E1 E2 e	4.45 4.25 3.75 6.35 6.05 4.40	4.60 4.30 3.95 6.50 6.10 4.60 2.10 BSC	4.75 4.35 4.15 6.65 6.15 4.80	
L L1 L2	0.90 0.15	1.10 0.25 REF 0.20	1.25 0.35	
R		0.10REF		
Note	1, 2			
Ref.				
Issue	DRAFT			

NOTE:

- 1 Dimensioning and torlerancing per ASME Y14.5M-1994.
- 2 All dimensions are in MILLIMETERS, angles are in degrees.
- A- Dimensions b1,b3 and c1 apply to base metal only,
 Dimensions b,b2 and c apply to plated leads,
 Dimensions b,c,b1,b2,b3,c1 to be measured on flat section of the lead, between 0.13 and 0.25 mm from lead tip.

JEDEC	TITLE:	ISSUE	DATE	ITEM #	SHEET
SOLID STATE PRODUCT OUTLINES	SMALL DUTLINES PLASTIC SURFACE MOUNT PACKAGE		Jan. 2006	TO-277	□F 3

Initial Issue: A	Date: 1/19/06	JC11 Item number: 10-436	
Change Record History			
		-	
Issue: A	Date: 1/19/06	Item Number: 11.10-436	
Description of Changes			
Outline creation	•	-	